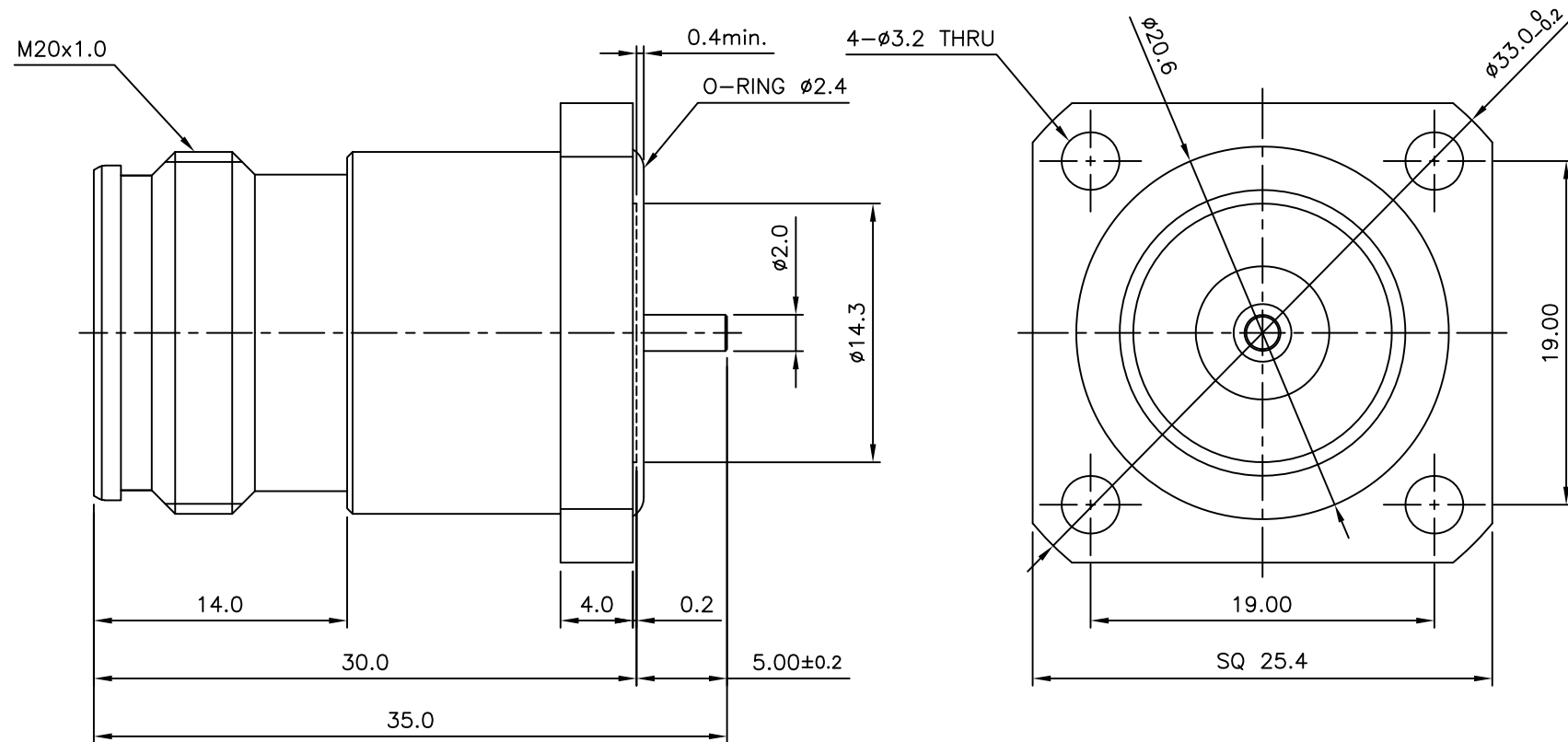
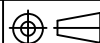


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2022. 07. 15.



5	JACK	1	MBsBD C3604BD-F	Silver Plate (3 μ m)	DJA00228-5/6
4	INSULATOR	1	TEFLON		DIN02716-N/1
3	GASKET	1	SILICONE RUB		DGK00047-N/1
2	CONTACT	1	BeCu C17300	Silver Plate (3 μ m)	DCT03628-5/2
1	BODY	1	MBsBD C3604BD-F	SUCO Plate	DBD04108-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2022. 07. 15.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY				
MATERIAL _____		CHECKED BY	TITLE 4.3-10 DIN50 SOLDER END JS-4H			
		DRAWN BY				S.H.KIM
FINISH _____	SCALE 2.5/1	UNIT mm		A4	DWG NO. CN03547-7/3	
					REVISION	I R